# PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT7144663

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	

#### **CONVEYING PARTY DATA**

Name	Execution Date
SHIGERU KOBAYASHI	12/02/2021
KAZUHIRO SHIBA	12/02/2021
MITSURU KURIHARA	12/06/2021
KAZUHIKO KURATA	12/01/2021

## **RECEIVING PARTY DATA**

Name:	AIO CORE CO., LTD.	
Street Address:	Street Address: 301, 1-47-12 SEKIGUCHI, BUNKYO-KU	
City:	TOKYO	
State/Country:	JAPAN	
Postal Code:	112-0014	

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number	
Application Number:	17585042	

### **CORRESPONDENCE DATA**

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

**Phone:** 202-747-9560

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ATTORNEY DOCKET NUMBER:	880221-9035-US01		
NAME OF SUBMITTER:	BRIAN K. DUTTON		
SIGNATURE:	/Brian K. Dutton/		
DATE SIGNED:	01/27/2022		
	This document serves as an Oath/Declaration (37 CFR 1.63).		

**Total Attachments: 3** 

PATENT REEL: 058794 FRAME: 0060 source=880221-9035-US01\_Declaration\_and\_Assignment#page1.tif source=880221-9035-US01\_Declaration\_and\_Assignment#page2.tif source=880221-9035-US01\_Declaration\_and\_Assignment#page3.tif

PATENT REEL: 058794 FRAME: 0061

#### **DECLARATION AND ASSIGNMENT**

## **OPTO-ELECTRIC MODULE**

	OFIO-ELECTRIC MODULE
	As a below named inventor, I hereby declare that:
	This declaration is directed to:
	<ul> <li></li></ul>
	The above-identified application was made or authorized to be made by me.
claimed inver	I believe that I am the original inventor or an original joint inventor of a antion in the application.
is punishable or both.	I hereby acknowledge that any willful false statement made in this declaration under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years,
application, in	I have reviewed and understand the contents of the above-identified including the claims.
patentability a	I acknowledge the duty to disclose information which is material to as defined in Title 37, Code of Federal Regulations § 1.56.
useful improv	WHEREAS, the below named inventor(s) have invented certain new and rements described in the above-identified application,
ku, Tokyo 11	AND WHEREAS, AIO Core Co., Ltd. of 301, 1-47-12 Sekiguchi, Bunkyo-2-0014 Japan
interest in, to invention and	and under the invention, the above-identified application disclosing the in, to and under any Letters Patent or similar legal protection which may be for in the United States and in any and all foreign countries:

NOW THEREFORE, for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, have assigned, sold and transferred, and do hereby assign, sell and transfer unto the ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the invention and the above-identified application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for the invention, and in and to any all priority rights and/or convention rights under the International Convention for the Protection

of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

This assignment executed on the date(s) indicated below.

Shigeru KOBAYASHI

Legal Name of Inventor

Signature of Inventor

Date Pecember 2, 2021

Additional inventors are named on the supplemental sheet(s) attached hereto.

# SUPPLEMENTAL SHEET(S) FOR DECLARATION AND ASSIGNMENT

K	azu	hire	SI	HBA

Legal Name of Joint Inventor (if applicable)

Kazuhro Shiha Signature of Joint Inventor

Date Dec, -2-2021

Mitsuru KURIHARA

Legal Name of Joint Inventor (if applicable)

Mitsuru Kurihara
Signature of Joint Inventor

Date Dec, -6 - 2021

Kazuhiko KURATA

**RECORDED: 01/27/2022** 

Legal Name of Joint Inventor (if applicable)

Kanonto Kingta Signature of Joint Inventor

Date <u>Pee. - 1 - 2021</u>